

# 'COTS' Modules

- for 35 years



Flemming CHRISTENSEN  
([Flemming.C@sundance.com](mailto:Flemming.C@sundance.com))  
Managing Director



[www.SUNDANCE.com](http://www.SUNDANCE.com)

# THE BUSINESS

Established in 1989 by Flemming CHRISTENSEN

- Employee Owned and a 'Life-Style' company
- 8x people with 300+ years experience, in the UK
  - 3x with accredited AMD FPGA training
- Similar-sized sister company in the USA
- Always designed and built our own products
- BSI - ISO9001-2015 certified since 2003



SUNDANCE

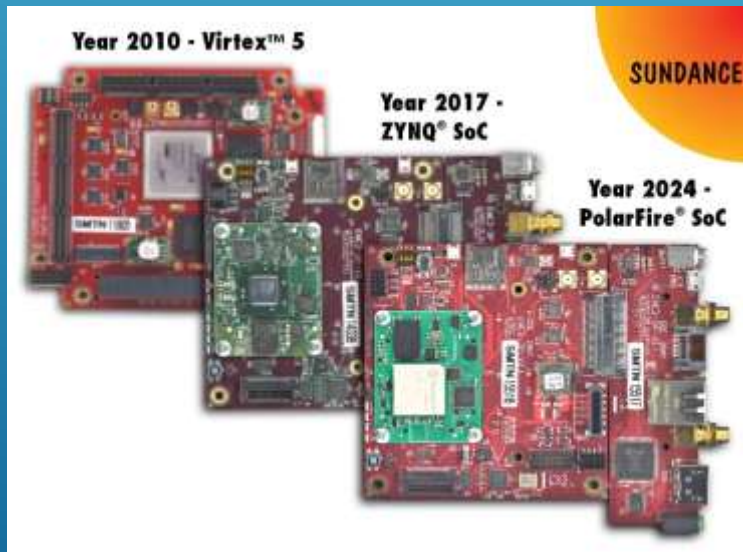
# THE BUSINESS

## Distribution Partners/Activities

- [Sundance Store](#) | Sundance and 3rd party products

## Technology Focus

- Edge-AI Acceleration, Vision, Sensor & Robotics
- Low-volume, high-tech manufacturing,
- In-House Manufacturing/Testing
- TRL3 (Prototype Boards)
- TRL8 (Application System)



# INDUSTRY FIRST COTS FPGA MODULE

SUNDANCE

- ▶ This, the SMT308, a “TIM40” form-factor Module for pre-processing of Video streams
- ▶ Complementing TI’s TMS320C40 DSPs with Parallel Interfaces to build Multiprocessing Systems.
- ▶ That was in 1993 and the first “Industry Standard” Module with an XILINX FPGA.
- ▶ [tim\\_spec\\_v1.01.pdf \(syndex.org\)](#)



*How many of you are using  
“System-on-Modules” ?*

# KINTEX ULTRASCALE – TE0841

[TE0841- Public Docs - Trenz Electronic Wiki](#)



[Module with AMD Kintex™ UltraScale™ KU040](#)

[XCKU040-1SFVA784I AMD | DigiKey](#)

**1+ Price: €1310.00**

**1+ Price: £1726.00**

# ZYNQ ULTRASCALE+ - TE0820

[TE0820 - Public Docs - Trenz Electronic Wiki](#)



[Module with AMD Zynq™ UltraScale+™ ZU3EG-1E](#)

[XCZU3EG-1SFVC784E AMD | DigiKey](#)

**1+ Price: £250.00**

**1+ Price: £439.00**

# ZYNQ ULTRASCALE+ - TE0821

[TE0821 - Public Docs - Trenz Electronic Wiki](#)



[Module with AMD Zynq™ UltraScale+™ ZU2CG-1E](#)

[XCZU2CG-1SFVC784E AMD | DigiKey](#)

**1+ Price: £250.00**

**1+ Price: £235.00**



# ZYNQ ULTRASCALE+ - TE0823

[TE0823 - Public Docs - Trenz Electronic Wiki](#)



[Module with AMD Zynq™ UltraScale+™ 3CG-L1I](#)

[XCZU3CG-L1SFVC784I AMD | DigiKey](#)

**1+ Price: £527.00**

**1+ Price: £523.00**

# ZYNQ – TE0715

[TE0715 - Public Docs - Trenz Electronic Wiki](#)



[Module with AMD Zynq™ 7012S-1C](#)

[XC7Z012S-1CLG485C AMD | DigiKey](#)

**1+ Price: £230.00**

**1+ Price: £89.00**

# ZYNQ – TE0720

[TE0720 - Public Docs - Trenz Electronic Wiki](#)



[Module with AMD Zynq™ 7020-1Q Automotive](#)

[XA7Z020-1CLG484Q AMD | DigiKey](#)

**1+ Price: £225.00**

**1+ Price: £153.00**

# ARTIX-7 – TE0710

[TE0710 - Public Docs - Trenz Electronic Wiki](#)



[Module with it AMD Artix™ 7 XC7AT-2FGG484I](#)

[XC7A35T-2FGG484I AMD | DigiKey](#)

**1+ Price: £116.00**

**1+ Price: £70.00**

# ARTIX-7 – TE0711

[TE0711 - Public Docs - Trenz Electronic Wiki](#)



[Module with AMD Artix™ 7 XC7A35T-2CSG324I](#)

[XC7A35T-2CSG324I AMD | DigiKey](#)

**1+ Price: £108.00**

**1+ Price: £57.00**

# ARTIX-7 – TE0712

[TE0712 - Public Docs - Trenz Electronic Wiki](#)



[Module with AMD Artix™ 7 XC7A100T-2FGG484C](#)

[XC7A100T-2FGG484C AMD | DigiKey](#)

**1+ Price: £230.00**

**1+ Price: £147.00**

# ARTIX-7 – TE0713

[TE0713 - Public Docs - Trenz Electronic Wiki](#)



[Module with AMD Artix™ 7 XC7A35T-2FGG484I](#)

[XC7A35T-2FGG484I AMD | DigiKey](#)

**1+ Price: £167.00**

**1+ Price: £70.00**

# POLARFIRE SOC – TEM0007

[TEM0007 - Public Docs - Trenz Electronic Wiki](#)



[Module with PolarFire® SoC MPFS095T-1FCVG484I](#)

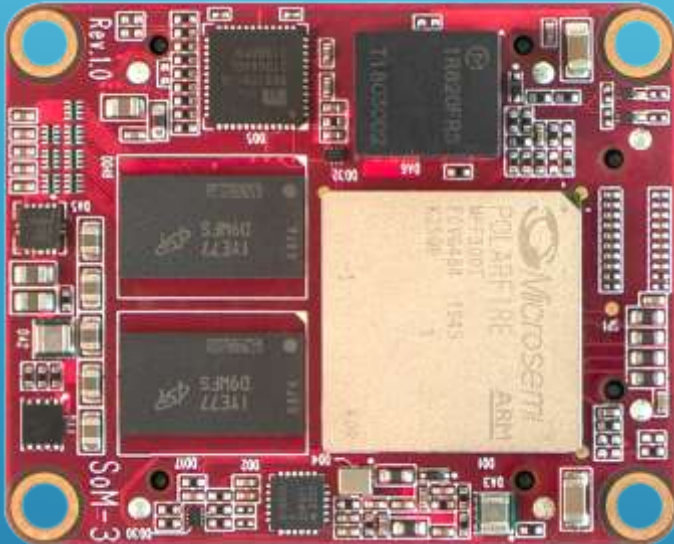
[MPFS095T-1FCVG484I | DigiKey](#)

**1+ Price: £259.00**

**1+ Price: £174.00**



# POLARFIRE FPGA – SOM3-MPF300



[SoM3-MPF300-1-E - Sundance Store](#)

[MPF300T-1FCVG484E | DigiKey](#)

**1+ Price: £1175.00**

**1+ Price: £443.00**

# ZYNQ ULTRASCALE+ – “SBC” ON A MODULE

<https://store.sundance.com/product/vcs3/>

- Cloud-less Computing
  - Low-Power Edge-AI
- Used in Mining Systems
  - (Monitoring of people)
- Used in AgriTech
  - (Precision spraying)
- Thermal and 3D imaging



Facial recognition



High accuracy



Multi-person Detection

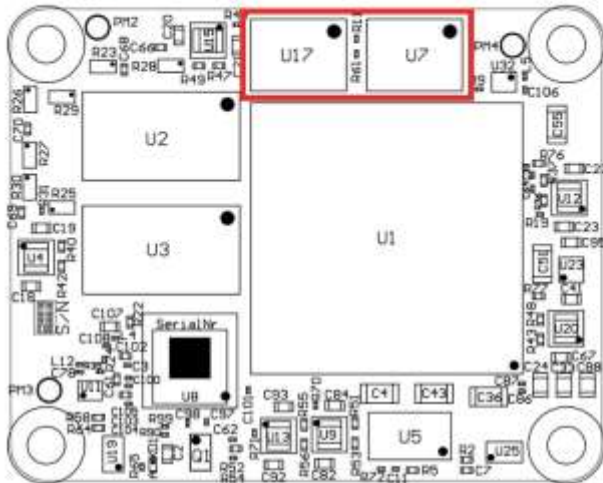


# THE TRENZ WAY – TE0820-01 TO -02

## How to manage lifetime supply and End-of-Life?

### Method of Identification

Locate Flash on topside of PCB:



N25Q256A11E1240E



N25Q512A11G1240E



### Changes

**#1 Change SPI Flash from N25Q256A11E1240E to N25Q512A11G1240E**

**Type:** BOM change

**Reason:** N25Q256A11E1240E became obsolete, replacement part not available for purchase. This is only interim solution because N25Q512A11G1240E is also obsolete already. It will be changed after the replacement parts get available.

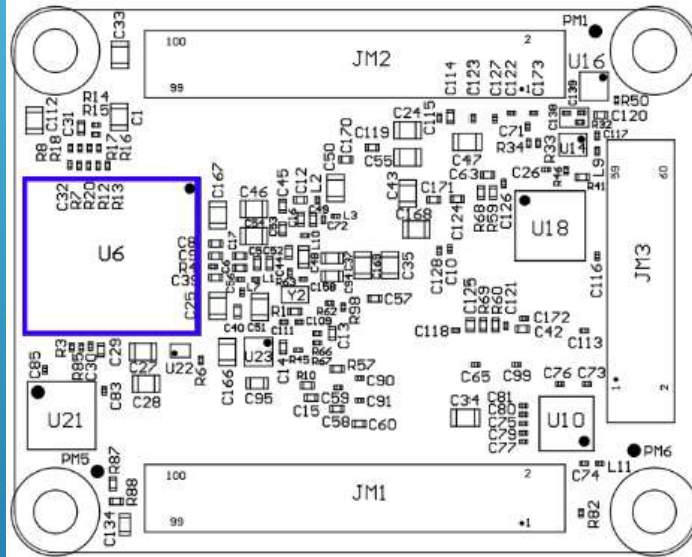
**Impact:** Size changed from 256 MBit to 512 MBit per chip. JEDEC ID changed from BB19h to BB20h both with manufacturer ID: 20h.

### PCN-20171117 TE0820-02 SPI Flash Change

<b>PCN Number</b>	PCN-20171117
<b>Title</b>	PCN-20171117 TE0820-02 SPI Flash Change
<b>Subject</b>	BOM change
<b>Issue Date</b>	20171117

# THE TRENZ WAY – TE0820-02 TO -03

## How to manage lifetime supply and End-of-Life?



**#2 Change eMMC from MTFC4GACAJCN-4M IT to IS21ES08G-JCLI**

**Type:** BOM change

**Reason:** Improve availability.

**Impact:** The eMMC capacity changed from 4 GByte to 8 GByte.

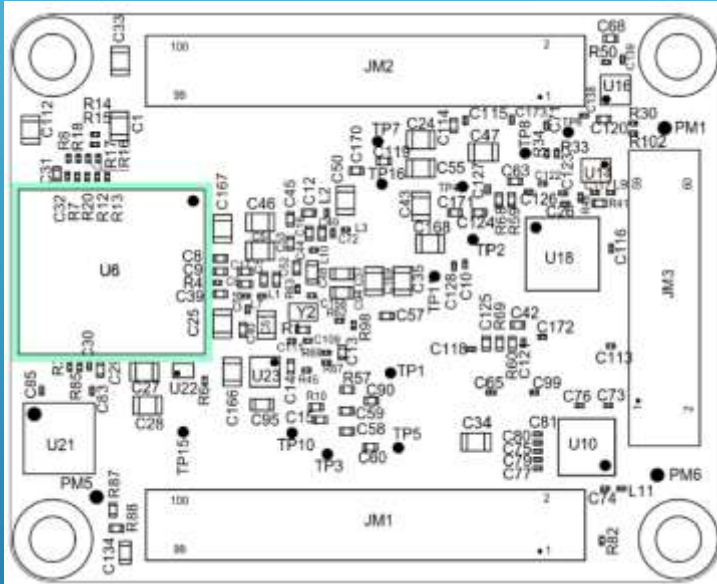
PCN-20190110a TE0820-03-\* SPI Flash and eMMC Change -



<b>PCN Number</b>	PCN-20190110a
<b>Title</b>	TE0820-03-* SPI Flash and eMMC Change
<b>Subject</b>	BOM change
<b>Issue Date</b>	2019-10-02

# THE TRENZ WAY – TE0820-03 TO -04

## How to manage lifetime supply and End-of-Life?



### Changes

**#1 Change eMMC (U6) from IS21ES08G-JCLI / IS21ES64G-JCLI to SDINBDG4-8G-XI2 / SDINBDG4-64G-XI2**

**Type:** BOM change

**Reason:** Distributor informed about unforeseeable immediate EOL of parts. No official documents from manufacturer are available. No LTB, already confirmed orders were cancelled by distributor/manufacturer.

**Impact:** None. Replacement has same capacity as used on corresponding affected variant. Reference designs for vivado versions 2019.2 and 2020.2 were tested and work properly without any changes.

**#2 Clock Revision Change (U14) SiT8008AI-73-XXS-52.000000E to SiT8008BI-73-XXS-52.000000E**

**Type:** BOM change

**Reason:** Switch to actual revision. Revision A devices may be discontinued.

**Impact:** None.

## PCN-20210615 TE0820-04 eMMC Change and Product Update



<b>PCN Number</b>	PCN-20210615
<b>Title</b>	TE0820-04 eMMC Change and Product Update
<b>Subject</b>	BOM change
<b>Issue Date</b>	2021-07-22

# THE TRENZ WAY – TE0820-04 TO -05

## How to manage lifetime supply and End-of-Life?



### Changes

#1 Changed DCDC (U4, U9, U12, U13, U15, U20, U24, U26, U27) from MUN3CAD03-SE to TPS82085SIL and adapted voltage divider resistors.

Type: BOM Change

Reason: TPS82085SIL availability.

Impact: Minor changes in electrical characteristics.

#2 Changed DDR4 SDRAM (U2, U3) from K4A8G165WB-BIRC to K4A8G165WC-BITDTCV.

Type: BOM change

Reason: BOM Optimization.

Impact: New DDR timings may be considered in designs. DDR4 setup used in reference design is known to work still.

## PCN-20231007 TE0820-05 DDR4 SDRAM and DCDC Change



PCN Number	PCN-20231007
Title	TE0820-05 DDR4 SDRAM and DCDC Change
Subject	BOM change
Issue Date	2023-10-23

# TE0820 – GROWING & SUPPORTED

*How TE0820 has grown and will continue until 2040!*

## Products Affected

This change affects all Trenz Electronic TE0820 SoMs: TE0820-02\*.

Affected Product	Replacement
TE0820-02-02CG-1E	TE0820-02-02CG-1EA
TE0820-02-02EG-1E	TE0820-02-02EG-1EA
TE0820-02-02EG-1E3	TE0820-02-02EG-1EL
TE0820-02-03CG-1E	TE0820-02-03CG-1EA
TE0820-02-03EG-1E	TE0820-02-03EG-1EA
TE0820-02-03EG-1E3	TE0820-02-03EG-1EL
TE0820-02-04CG-1E	TE0820-02-04CG-1EA
TE0820-02-04EV-1E	TE0820-02-04EV-1EA

*How TE0820 has grown from eight (8) build variations in 2017 to almost forty (40) in 2024 - and will continue until 2045!*

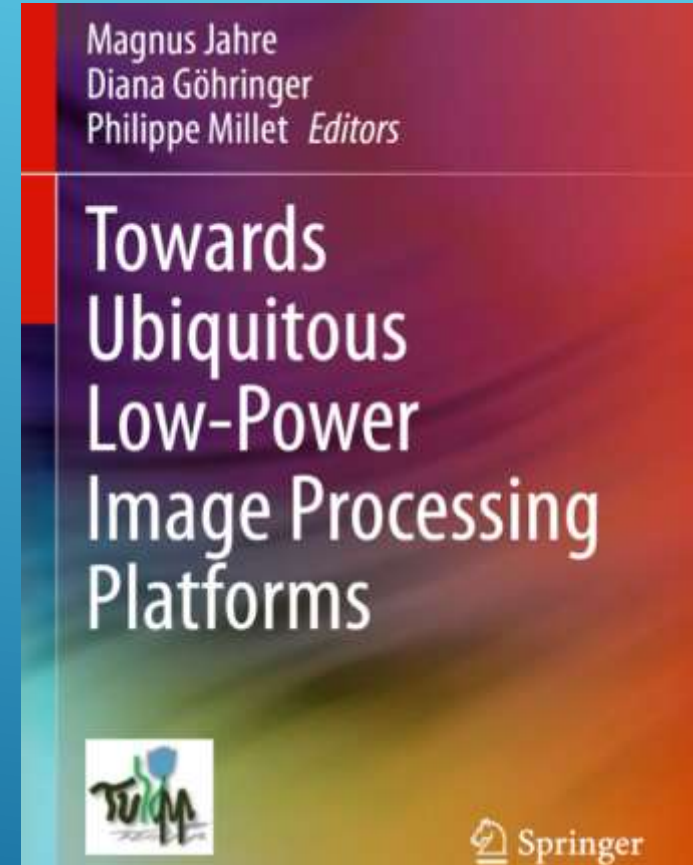
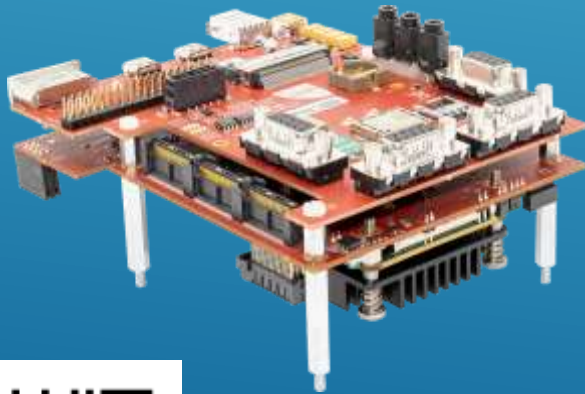
## Products Affected

This change affects all Trenz Electronic TE0820 SoMs: TE0820-05\*.

Affected Product	Changes	Replacement
TE0820-05-2AE21MA	#2	TE0820-05-2AE81MA
TE0820-05-2AE21MAZ	#1, #2	TE0820-05-2AE81MA
TE0820-05-2AI21MA	#2	TE0820-05-2AI81MA
TE0820-05-2AI21MAZ	#1, #2	TE0820-05-2AI81MA
TE0820-05-2AJ21MC	#2	TE0820-05-2AJ81MC
TE0820-05-2AJ21MCZ	#1, #2	TE0820-05-2AJ81MC
TE0820-05-2BE21MA	#2	TE0820-05-2BE81MA
TE0820-05-2BE21MAJ	#2	TE0820-05-2BE81MAJ
TE0820-05-2BE21MAZ	#1, #2	TE0820-05-2BE81MA
TE0820-05-2BE21ML	#2	TE0820-05-2BE81ML
TE0820-05-2BE21MLZ	#1, #2	TE0820-05-2BE81ML
TE0820-05-2BI21MA	#2	TE0820-05-2BI81MA
TE0820-05-2BI21MAZ	#1, #2	TE0820-05-2BI81MA
TE0820-05-2BI21ML	#2	TE0820-05-2BI81ML
TE0820-05-2BI21MLZ	#1, #2	TE0820-05-2BI81ML
TE0820-05-3AE21MA	#2	TE0820-05-3AE81MA
TE0820-05-3AE21MAZ	#1, #2	TE0820-05-3AE81MA
TE0820-05-3BE21MA	#2	TE0820-05-3BE81MA
TE0820-05-3BE21MAZ	#1, #2	TE0820-05-3BE81MA
TE0820-05-3BE21ML	#2	TE0820-05-3BE81ML
TE0820-05-3BE21MLZ	#1, #2	TE0820-05-3BE81ML
TE0820-05-3BI21ML	#2	TE0820-05-3BI81ML
TE0820-05-3BI21MLZ	#1, #2	TE0820-05-3BI81ML
TE0820-05-4AE21MA	#2	TE0820-05-4AE81MA
TE0820-05-4AE21MAZ	#1, #2	TE0820-05-4AE81MA
TE0820-05-4AI21MC	#2	TE0820-05-4AI81MC
TE0820-05-4AI21MCZ	#1, #2	TE0820-05-4AI81MC
TE0820-05-4AJ21MI	#2	TE0820-05-4AJ81MI
TE0820-05-4BI21KL	#2	TE0820-05-4BI81KL
TE0820-05-4BI21PL	#2	TE0820-05-4BI81PL
TE0820-05-4BI21PLZ	#1, #2	TE0820-05-4BI81PL
TE0820-05-4DE21MA	#2	TE0820-05-4DE81MA
TE0820-05-4DE21MAZ	#1, #2	TE0820-05-4DE81MA
TE0820-05-4DI21MA	#2	TE0820-05-4DI81MA
TE0820-05-4DI21MAZ	#1, #2	TE0820-05-4DI81MA
TE0820-05-5DQ21MA	#2	TE0820-05-5DQ81MA
TE0820-05-5DI21MAZ	#1, #2	TE0820-05-5DI81MA
TE0820-05-5DR21MA	#2	TE0820-05-5DQ81MA
TE0820-05-5DR21MAZ	#1, #2	TE0820-05-5DQ81MA

# EMC2 – PC/104 CARRIER

- ▶ Developed for an EU-funded project, “TULLIPP”,
- ▶ Carrier for Open-Source 40mm x 50mm SoM Modules





*Do you use 'Industry Standard' COTS  
Embedded Boards?*

# OPEN-SOURCE HARDWARE

SUNDANCE



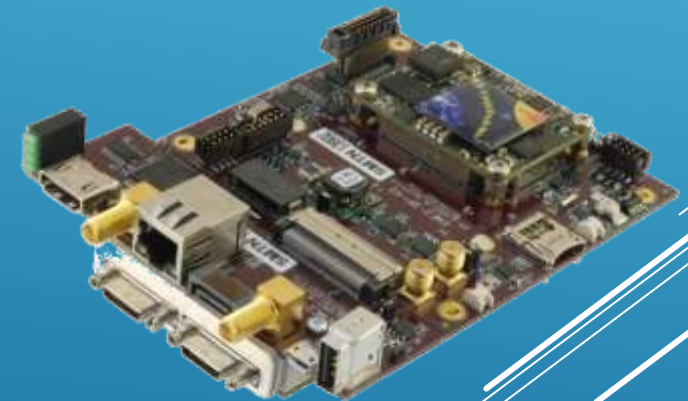
open source  
hardware

Introduced by CERN in 2007

[Home](#) · [Wiki](#) / [CERN Open Hardware Licence](#) · [GitLab \(ohwr.org\)](#)

Sundance added this in 2021:

[Home](#) · [Wiki](#) · [Projects](#) / [EMC2-DP](#) · [GitLab \(ohwr.org\)](#)



 **PC/104**

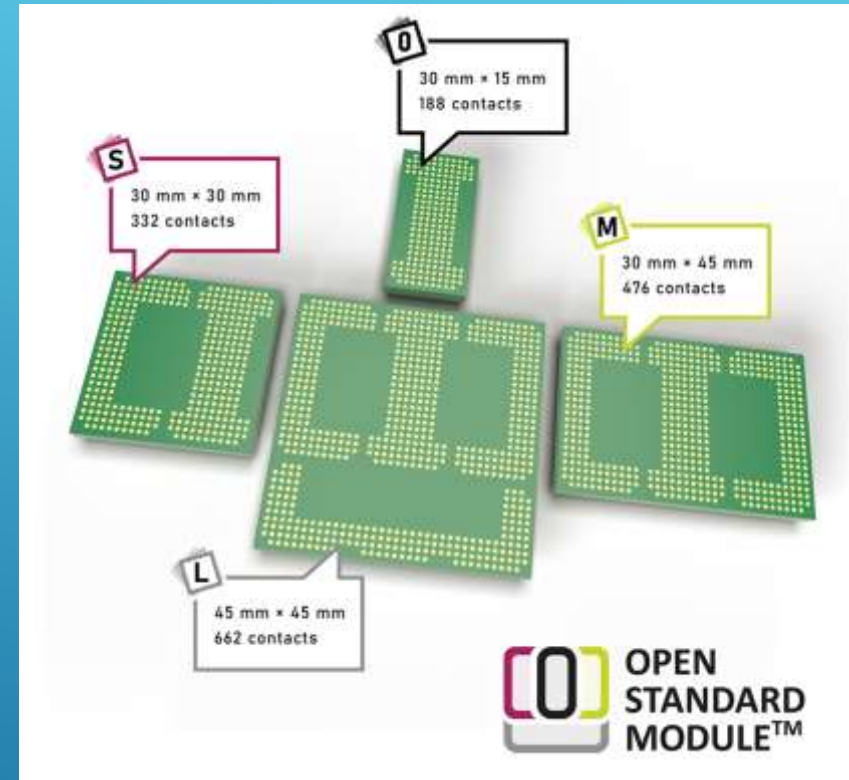
26

[www.SUNDANCE.com](http://www.SUNDANCE.com)



# WHAT ABOUT OSM?

## Open Standard Module (OSM) standard and specifications - SGET



# AN FPGA MODULE STANDARD?

Harmonized FPGA Module (HFM) standard and specifications - SGET



# SUMMARY

- ▶ Main reasons for SoM Modules?
  - ▶ Redundancy, Obsolescence & Cost
- ▶ Why opt for “Open Hardware” Modules?
  - ▶ You should get the circuit diagrams
- ▶ Technical benefits?
  - ▶ You can focus on carrier, firmware and software
  - ▶ Support from an experienced Team with sharing application
- ▶ Commercial benefits?
  - ▶ The cost of a typical SoM is similar to the cost of the device
  - ▶ Less stock, Less risk

# LAST QUESTION – ANY QUESTIONS?

SUNDANCE



[www.SUNDANCE.com](http://www.SUNDANCE.com)